# FSA3031－Dual High－Speed USB2．0 with Mobile High－Definition Link（MHL ${ }^{\text {M }}$ ） 

## Features

－Low On Capacitance： 4.6 pF／6．75 pF MHL／USB （Typical）
－Low Power Consumption： $30 \mu \mathrm{~A}$ Maximum
－Supports MHL Rev． 2.0
－Passes 1080 p／60 fps（3 Gbps）MHL Data Eye Diagram Mask Compliance
－MHL Data Rate：$\geq 4.7 \mathrm{Gbps}$ with Ideal Input Source
－Packaged in 12－Lead UMLP（ $1.8 \times 1.8 \mathrm{~mm}$ ）
－Over－Voltage Tolerance（OVT）on all USB Ports Up to 5.25 V without External Components

## Applications

－Cell Phones and Digital Cameras

## IMPORTANT NOTE：

For additional performance information，please contact interface＠fairchildsemi．com．

## Description

The FSA3031 is a bi－directional，low－power，high－speed， 3：1，dual USB2．0 and MHL switch．Configured as a double－pole，triple－throw（DP3T）switch；it is optimized for switching between dual high－or full－speed USB and Mobile High－Definition Link sources（MHL ${ }^{\text {TM }}$ Rev． 2.0 specification）．
The FSA3031 contains special circuitry on the switch I／O pins，for applications where the $V_{c c}$ supply is powered off $\left(\mathrm{V}_{\mathrm{cc}}=0\right)$ ，that allows the device to withstand an over－voltage condition．This switch is designed to minimize current consumption even when the control voltage applied to the control pins is lower than the supply voltage（ $\mathrm{V}_{\mathrm{CC}}$ ）．This feature is especially valuable to mobile applications，such as cell phones；allowing direct interface with the general－purpose I／Os of the baseband processor．Other applications include switching and connector sharing in portable cell phones， digital cameras，and notebook computers．

## Ordering Information

| Part Number | Top Mark | Operating Temperature Range | Package |
| :---: | :---: | :---: | :---: |
| FSA3031UMX | LX | -40 to $+85^{\circ} \mathrm{C}$ | 12－Lead，Ultrathin Molded Leadless Package <br> $($ UMLP $), 1.8 \mathrm{~mm} \times 1.8 \mathrm{~mm}$ |



Figure 1．Typical Application
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## Analog Symbol



Figure 2. Analog Symbol

Table 1. Data Switch Select Truth Table

| SEL1 $^{(1)}$ | SELO $^{(1)}$ | Function |
| :---: | :---: | :--- |
| 0 | 0 | D+/D- connected to USB1+/USB1- |
| 0 | 1 | D+/D- connected to USB2+/USB2- |
| 1 | 0 | D+/D- connected to MHL+/MHL |
| 1 | 1 | D+/D- high impedance |

## Note:

1. Control inputs should never be left floating or unconnected. To guarantee default switch closure to the USB position, the $\operatorname{SEL[0:1]~pins~should~be~tied~to~GND~with~a~weak~pull-down~resistor~(~} 3 \mathrm{M} \Omega$ ) to minimize static current draw.

## Pin Configuration



Figure 3. Pin Assignments


Figure 4. Top Through View

## Pin Definitions

| Pin\# | Name |  |
| :---: | :---: | :--- |
| 1 | SEL0 | Data Switch Select |
| 2 | SEL1 | Data Switch Select |
| 3 | USB1+ | USB Differential Data (Positive) - Source 1 |
| 4 | USB1- | USB Differential Data (Negative) - Source 1 |
| 5 | USB2+ | USB Differential Data (Positive) - Source 2 |
| 6 | USB2- | USB Differential Data (Negative) - Source 2 |
| 7 | MHL+ | MHL Differential Data (Positive) |
| 8 | MHL- | MHL Differential Data (Negative) |
| 9 | GND | Ground |
| 10 | D- | Data Switch Output (Positive) |
| 11 | D+ | Data Switch Output (Negative) |
| 12 | Vcc | Device Power from System |

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter |  | Min. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {cc }}$ | Supply Voltage |  | -0.5 | 6.0 | V |
| $\mathrm{V}_{\text {CNTRL }}$ | DC Input Voltage (SEL[1:0]) ${ }^{(2)}$ |  | -0.5 | $\mathrm{V}_{\mathrm{cc}}$ | V |
| $\mathrm{V}_{\mathrm{sw}}{ }^{(3)}$ | DC Switch I/O Voltage ${ }^{(2)}$ | USB | -0.50 | $\mathrm{V}_{\mathrm{cc}}$ | V |
|  |  | MHL | -0.50 | $\mathrm{V}_{\mathrm{Cc}}$ |  |
| $\mathrm{I}_{\text {K }}$ | DC Input Diode Current |  | -50 |  | mA |
| lout | Switch DC Output Current (Continuous) | USB |  | 60 | mA |
|  |  | MHL |  | 60 | mA |
| loutpeak | Switch DC Output Peak Current (Pulsed at 1m Duration, <10\% Duty Cycle) | USB |  | 150 | mA |
|  |  | MHL |  | 150 | mA |
| TSTG | Storage Temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| MSL | Moisture Sensitivity Level (JEDEC J-STD-020A) |  |  | 1 |  |
| ESD | Human Body Model, JEDEC: JESD22-A114 | All Pins |  | 4 | kV |
|  | IEC 61000-4-2, Level 4, for D+/D- and $\mathrm{V}_{\mathrm{cc}}$ Pins ${ }^{(4)}$ | Contact |  | 8 |  |
|  | IEC 61000-4-2, Level 4, for D+/D- and $\mathrm{V}_{\text {cc }}$ Pins ${ }^{(4)}$ | Air |  | 15 |  |
|  | Charged Device Model, JESD22-C101 |  |  | 2 |  |

## Notes:

2. The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.
3. $\mathrm{V}_{\mathrm{SW}}$ refers to analog data switch paths (USB1, MHL, and USB2).
4. Testing performed in a system environment using TVS diodes.

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol | Parameter | Min. | Max. | Unit |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply Voltage | 2.5 | 4.5 | V |
| $\mathrm{t}_{\mathrm{RAMP}(\mathrm{VCC})}$ | Power Supply Slew Rate | 100 | 1000 | $\mu \mathrm{~s} / \mathrm{V}$ |
| $\Theta_{\mathrm{JA}}$ | Thermal Resistance |  | 230 | $\mathrm{C} / \mathrm{W}$ |
| $\mathrm{V}_{\mathrm{CNTRL}}$ | Control Input Voltage (SEL[1:0]) $)^{(5)}$ | 0 | 4.5 | V |
| $\mathrm{~V}_{\mathrm{SW}(\mathrm{USB})}$ | Switch I/O Voltage (USB1/USB2 Switch Paths) | -0.5 | 3.6 | V |
| $\mathrm{~V}_{\mathrm{SW}(\mathrm{MHL})}$ | Switch I/O Voltage (MHL Switch Path) | 1.65 | 3.45 | V |
| $\mathrm{~T}_{\mathrm{A}}$ | Operating Temperature | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |

## Note

5. The control inputs must be held HIGH or LOW; they must not float.

## DC Electrical Characteristics

All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise specified.

| Symbol | Parameter | Condition | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| $\mathrm{V}_{\mathrm{IK}}$ | Clamp Diode Voltage | $\mathrm{I}_{1 \times}=-18 \mathrm{~mA}$ | 2.5 |  |  | -1.2 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Control Input Voltage, High SEL[1:0] |  | 2.5 to 4.5 | 1.0 |  |  | V |
| VIL | Control Input Voltage, Low SEL[1:0] |  | 2.5 to 4.5 |  |  | 0.5 | V |
| In | Control Input Leakage, SEL[1:0] | $\begin{aligned} & \mathrm{V}_{\mathrm{SW}}=0 \text { to } 3.6 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{CNTRL}}=0 \text { to } \mathrm{V}_{\mathrm{CC}} \end{aligned}$ | 4.5 | -0.5 |  | 0.5 | $\mu \mathrm{A}$ |
| loZ (MHL) | Off-State Leakage for Open MHL Data Paths | $\begin{aligned} & \mathrm{V}_{\mathrm{SW}}=1.65 \leq \mathrm{MHL} \\ & \leq 3.45 \mathrm{~V}, \mathrm{SEL}[1: 0]=\mathrm{V}_{\mathrm{cc}} \end{aligned}$ | 4.5 | -0.5 |  | 0.5 | $\mu \mathrm{A}$ |
| loz(USB) | Off-State Leakage for Open USB Data Paths | $\begin{aligned} & \mathrm{V}_{\mathrm{SW}}=0 \leq \mathrm{USB} \leq 3.6 \mathrm{~V}, \\ & \mathrm{SEL}[1: 0]=\mathrm{V}_{\mathrm{cc}} \end{aligned}$ | 4.5 | -0.5 |  | 0.5 | $\mu \mathrm{A}$ |
| $\mathrm{ICL}_{\text {(MHL) }}$ | On-State Leakage for Closed MHL Data Paths ${ }^{(6)}$ | $\mathrm{V}_{\mathrm{Sw}}=1.65 \leq \mathrm{MHL} \leq 3.45 \mathrm{~V},$ <br> SELO=GND, SEL1= $\mathrm{V}_{\mathrm{Cc}}$, Other <br> Side of Switch Float | 4.5 | -0.5 |  | 0.5 | $\mu \mathrm{A}$ |
| $\mathrm{ICL}_{\text {LUSB })}$ | On-State Leakage for Closed USB Data Paths ${ }^{(6)}$ | $\mathrm{V}_{\mathrm{sw}}=0 \leq \mathrm{USB} \leq 3.6 \mathrm{~V}$ SEL[1:0]=GND or SEL1=GND, <br> SELO $=\mathrm{V}_{\mathrm{cc}}$, Other Side of Switch Float | 4.5 | -0.5 |  | 0.5 | $\mu \mathrm{A}$ |
| loff | Power-Off Leakage Current (All I/O Ports) | $\mathrm{V}_{\mathrm{sw}}=0 \mathrm{~V}$ or 3.6 V, Figure 5 | 0 | -0.5 |  | 0.5 | $\mu \mathrm{A}$ |
| $\mathrm{R}_{\text {on(USB) }}$ | HS Switch On Resistance (USB to D Path) | $\mathrm{V}_{\mathrm{SW}}=0.4 \mathrm{~V}$, $\mathrm{l}_{\mathrm{oN}}=-8 \mathrm{~mA}$ SEL[1:0]=GND or SEL1=GND, SELO $=\mathrm{V}_{\mathrm{cc}}$, Figure 6 | 2.5 |  | 3.9 | 6.5 | $\Omega$ |
| $\mathrm{R}_{\text {ON(MHL) }}$ | HS Switch On Resistance (MHL to D Path) | $\begin{aligned} & \mathrm{V}_{\mathrm{SW}}=\mathrm{V}_{\mathrm{CC}}-1050 \mathrm{mV}, \\ & \mathrm{SELO}=\mathrm{GND}, \mathrm{SEL} 1=\mathrm{V}_{\mathrm{CC}}, \\ & \mathrm{l}_{\mathrm{ON}}=-8 \mathrm{~mA}, \text { Figure } 6 \end{aligned}$ | 2.5 |  | 5 |  | $\Omega$ |
| $\Delta \mathrm{R}_{\text {ON(MHL) }}$ | Difference in Ron Between MHL Positive-Negative | $\begin{aligned} & \mathrm{V}_{\mathrm{SW}}=\mathrm{V}_{\mathrm{Cc}}-1050 \mathrm{mV}, \\ & \mathrm{SELO}=\mathrm{GND}, \mathrm{SEL} 1=\mathrm{V}_{\mathrm{Cc}}, \\ & \mathrm{l}_{\mathrm{ON}}=-8 \mathrm{~mA}, \text { Figure } 6, \end{aligned}$ | 2.5 |  | 0.03 |  | $\Omega$ |
| $\Delta \mathrm{R}_{\text {on(Usb) }}$ | Difference in Ron Between USB Positive-Negative | $\mathrm{V}_{\mathrm{SW}}=0.4 \mathrm{~V}$, $\mathrm{I}_{\mathrm{ON}}=-8 \mathrm{~mA}$, SEL[1:0]=GND or SEL1=GND, SELO $=\mathrm{V}_{\text {CC }}$ Figure 6 | 2.5 |  | 0.22 |  | $\Omega$ |
| Ronf(MHL) | Flatness for Row MHL Path | $\begin{aligned} & \mathrm{V}_{\mathrm{SW}}=1.65 \text { to } 3.45 \mathrm{~V}, \\ & \mathrm{SELO}=\mathrm{GND}, \mathrm{SEL} 1=\mathrm{V}_{\mathrm{Cc}}, \\ & \mathrm{l}_{\mathrm{ON}}=-8 \mathrm{~mA}, \text { Figure } 6 \\ & \hline \end{aligned}$ | 2.5 |  | 1 |  | $\Omega$ |
| $\mathrm{I}_{\mathrm{Cc}}$ | Quiescent Current | $\mathrm{V}_{\text {CNTRL }}=0$ or 4.5 V , I $\mathrm{l}_{\text {OUT }}=0$ | 4.5 |  |  | 30 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {cct }}$ | Delta Increase in Quiescent Current per Control Pin | $\mathrm{V}_{\text {CNTRL }}=1.65 \mathrm{~V}$, I $\mathrm{l}_{\text {OUT }}=0$ | 4.5 |  |  | 18 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {CNTRL }}=2.5 \mathrm{~V}$, $\mathrm{I}_{\text {OUT }}=0$ | 4.5 |  |  | 10 |  |

## Note:

6. For this test, the data switch is closed with the respective switch pin floating.

## AC Electrical Characteristics

All typical values are for $\mathrm{V}_{C C}=3.3 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise specified.

| Symbol | Parameter | Condition | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. | Typ. | Max. |  |
| tonusb | USB Turn-On Time, SEL[1:0] to Output | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{~V}_{\mathrm{SW}(\mathrm{USB})}=0.8 \mathrm{~V} \text {, }$ $V_{S W(M H L)}=3.3 \vee \text {, Figure 7, Figure } 8$ | 2.5 to 3.6 |  | 445 | 600 | ns |
| toffusb | USB Turn-Off Time, SEL[1:0] to Output | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{~V}_{\mathrm{SW}(\mathrm{USB})}=0.8 \mathrm{~V} \text {, }$ $V_{S W(M H L)}=3.3 \mathrm{~V} \text {, Figure 7, Figure } 8$ | 2.5 to 3.6 |  | 445 | 600 | ns |
| tonmbl | MHL Turn-On Time, SEL[1:0] to Output | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{V}_{\mathrm{Sw}(\mathrm{USB})}=0.8 \mathrm{~V}$, $\mathrm{V}_{\mathrm{SW}(\mathrm{MHL})}=3.3 \mathrm{~V}$, Figure 7, Figure 8 | 2.5 to 3.6 |  | 445 | 600 | ns |
| $\mathrm{t}_{\text {OFFMHL }}$ | MHL Turn-Off Time, SEL[1:0] to Output | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{V}_{\mathrm{Sw}(\mathrm{USB})}=0.8 \mathrm{~V}$, $\mathrm{V}_{\mathrm{SW}(\mathrm{MHL})}=3.3 \mathrm{~V}$, Figure 7, Figure 8 | 2.5 to 3.6 |  | 445 | 600 | ns |
| $\mathrm{t}_{\text {PD }}$ | Propagation Delay ${ }^{(7)}$ | $\mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, Figure 7, Figure 9 | 2.5 to 3.6 |  | 0.25 |  | ns |
| $\mathrm{t}_{\text {BBM }}$ | Break-Before-Make Time ${ }^{(7)}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{~V}_{\mathrm{ID}}=\mathrm{V}_{\mathrm{MHL}}=3.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{USB}}=0.8 \mathrm{~V} \text {, Figure } 11 \end{aligned}$ | 2.5 to 3.6 |  | 85 |  | ns |
| OIRR (MHL) | Off Isolation ${ }^{(7)}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=1 \mathrm{~V}_{\text {pk-pk }}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{f}=240 \mathrm{MHz}, \\ & \text { Figure } 12 \end{aligned}$ | 2.5 to 3.6 |  | -41 |  | dB |
| OIRR (USB) |  | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=400 \mathrm{mV}_{\text {pk-pk }}, R_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=240 \mathrm{MHz}, \text { Figure } 12 \end{aligned}$ | 2.5 to 3.6 |  | -36 |  | dB |
| Xtalk ${ }_{\text {MHL }}$ | Non-Adjacent Channel ${ }^{(7)}$ Crosstalk | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=1 \mathrm{~V}_{\text {pk-pk }}, \mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{f}=240 \mathrm{MHz}, \\ & \text { Figure } 13 \end{aligned}$ | 2.5 to 3.6 |  | -41 |  | dB |
| Xtalkusb |  | $\begin{aligned} & \mathrm{V}_{\mathrm{S}}=400 \mathrm{mV}_{\text {pk-pk }}, R_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=240 \mathrm{MHz}, \text { Figure } 13 \end{aligned}$ | 2.5 to 3.6 |  | -37 |  | dB |
| BW | Differential -3db Bandwidth ${ }^{(7)}$ | $\mathrm{V}_{\mathrm{IN}}=1 \mathrm{~V}_{\mathrm{pk}-\mathrm{pk}}, \mathrm{MHL}$ Path, Common Mode Voltage $=\mathrm{V}_{\mathrm{cc}}-1.1 \mathrm{~V}$, $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=0 \mathrm{pF}$, Figure 14 | 2.5 to 3.6 |  | 1.87 |  | GHz |
|  |  | $\mathrm{V}_{\mathrm{IN}}=400 \mathrm{~m} \mathrm{~V}_{\mathrm{pk} \text {-pk }}$, USB Path, Common Mode Voltage $=0.2 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, $\mathrm{C}_{\mathrm{L}}=0 \mathrm{pF}$, Figure 14 |  |  | 1.47 |  |  |

Note:
7. Guaranteed by characterization.

## USB High-Speed AC Electrical Characteristics

Typical values are at $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

| Symbol | Parameter | Condition | $\mathbf{V}_{\mathbf{c c}}(\mathrm{V})$ | Typ. | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{SK}(\mathrm{P})}$ | Skew of Opposite Transitions of the <br> Same Output ${ }^{(8)}$ | $\mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=50 \Omega$, Figure 9 | 3.0 to 3.6 | 7 | ps |
| $\mathrm{t}_{\mathrm{J}}$ | Total Jitter ${ }^{(8)}$ | $\mathrm{R}_{\mathrm{L}}=50 \Omega, \mathrm{C}_{\mathrm{L}}=5 \mathrm{pF}, \mathrm{t}_{\mathrm{R}}=\mathrm{t}_{\mathrm{F}}=500 \mathrm{ps}$ <br> $(10-90 \%)$ at $480 \mathrm{Mbps}, \mathrm{PN} 7$ | 3.0 to 3.6 | 18 | ps |

Note:
8. Guaranteed by characterization.

## MHL AC Electrical Characteristics

Typical values are at $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

| Symbol | Parameter | Condition | $\mathrm{V}_{\mathrm{cc}}(\mathrm{V})$ | Typ. | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{SK}(\mathrm{P})}$ | Skew of Opposite Transitions of the <br> Same Output |  |  |  |  |
| $\mathrm{t}_{\mathrm{J}}$ | Total Jitter $^{(9)}$ | $\mathrm{R}_{\mathrm{PU}}=50 \Omega$ to $\mathrm{V}_{\mathrm{CC}}, \mathrm{C}_{\mathrm{L}}=0 \mathrm{pF}$ | 3.0 to 3.6 | 3 | ps |

Note:
9. Guaranteed by characterization.

## Capacitance

Typical values are at $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

| Symbol | Parameter | Condition | Typ. | Max. | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{C}_{\mathrm{IN}}$ | Control Pin Input Capacitance ${ }^{(10)}$ | $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | 2.5 |  | pF |
| $\mathrm{C}_{\mathrm{ON}(\mathrm{USB})}$ | USB Path On Capacitance ${ }^{(10)}$ | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{f}=240 \mathrm{MHz}$, Figure 15 | 6.75 |  | pF |
| $\mathrm{C}_{\mathrm{OFF}(\mathrm{USB})}$ | USB Path Off Capacitance ${ }^{(10)}$ | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{f}=240 \mathrm{MHz}$, Figure 13 | 2.5 |  | pF |
| $\mathrm{C}_{\mathrm{ON}(\mathrm{MHL})}$ | MHL Path On Capacitance ${ }^{(10)}$ | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{f}=240 \mathrm{MHz}$, Figure 15 | 4.6 |  | pF |
| $\mathrm{C}_{\mathrm{OFF}(\mathrm{MHL})}$ | MHL Path Off Capacitance ${ }^{(10)}$ | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{f}=240 \mathrm{MHz}$, Figure 13 | 2.5 |  | pF |

## Note:

10. Guaranteed by characterization.

## Test Diagrams


**Each switch port is tested separately

Figure 5. Off Leakage

$R_{S}$, and $C_{L}$ are functions of the application environment (see AC Tables for speafic values) $C_{\_}$includes test fixture and stray capaditance.

Figure 7. AC Test Circuit Load


Figure 9. Propagation Delay ( $\mathrm{t}_{\mathrm{R}} \mathrm{t}_{\mathrm{F}}-500 \mathrm{ps}$ )


$$
\mathrm{RON}=\mathrm{V}_{\mathrm{ON}} / \mathrm{l}_{\mathrm{ON}}
$$

Figure 6. On Resistance


Figure 8. Turn-On / Turn-Off Waveforms


Figure 10. Intra-Pair Skew Test $\mathbf{t s k}_{\text {(P) }}$

## Test Diagrams



Figure 11. Break-Before-Make Interval Timing

$V_{S}, R_{S}$ and $R_{T}$ are functions of the application environment (see AC/DC Tables for values). Off Isolation $=20$ Log $\left(V_{\text {OUT }}-V_{\text {IN }}\right)$

Figure 12. Channel Off Isolation (SDD21)


VS, RS and RT are functions of the application environment (see AC/DC Tables for values). Off Isolation $=20$ Log (VOUT -VIN )

Figure 13. Non-Adjacent Channel-to-Channel Crosstalk (SDD21)

## Test Diagrams



Figure 14. Insertion Loss (SDD21)


Figure 15. Channel Off Capacitance

## Note:

11. $\mathrm{HSD}_{\mathrm{n}}$ refers to the high-speed data USB or MHL paths.


Figure 16. Channel On Capacitance

## Functional Description

## Insertion Loss

One of the key advantages of using the FSA3031 in mobile digital video applications is the small amount of insertion loss experienced by the received signal as it passes through the switch.

This results in minimal degradation of the received eye. One of the ways to measure the quality of the high data rate channels is using balanced ports and four-port differential S-parameter analysis, particularly SDD21.
Bandwidth is measured using the S-parameter SDD21 methodology. Figure 17 exhibits the $1.87 \mathrm{GHz}(-3 \mathrm{db})$ BW of the MHL path, while Figure 18 exhibits the $1.47 \mathrm{GHz}(-3 \mathrm{db}) \mathrm{BW}$ of the USB paths.


Figure 17. MHL Path SDD21 Insertion Loss Curve


Figure 18. USB Path SDD21 Insertion Loss Curve

## Typical Application

Figure 19 shows utilizing the VBAT connection from the micro-USB connector. The 3 M resistors are used to ensure, for manufacturing test via the micro-USB connector, that the FSA3031 configures for connectivity to the baseband or application processor.


Figure 19. Typical Application

## Physical Dimensions



Figure 20. 12-Lead, Ultrathin Molded Leadless Package (UMLP)

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| AX-CAPти* | Global Power Resource ${ }^{\text {SM }}$ | Programmable Active Droop ${ }^{\text {TM }}$ | ranchise |
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| CROSSVOLT ${ }^{\text {m }}$ | GTO ${ }^{\text {™ }}$ | $)^{T M}$ | TINYOPTO ${ }^{\text {™ }}$ |
| CTL ${ }^{\text {TM }}$ | IntelliMAX ${ }^{\text {TM }}$ | Saving our world, $1 \mathrm{mWNW} / \mathrm{KW}$ at a time ${ }^{\text {TM }}$ | TinyPower ${ }^{\text {TM }}$ |
| Current Transfer Logic ${ }^{\text {TM }}$ | ISOPLANAR ${ }^{\text {TM }}$ M | SignalWise ${ }^{\text {TM }}$ | TinyPWM ${ }^{\text {m }}$ |
| DEUXPEED ${ }^{\text {D }}$ | Making Small Speakers Sound Louder and Better ${ }^{\text {TM }}$ | SmartMax ${ }^{\text {TM }}$ | TinyWire ${ }^{\text {TM }}$ |
| Ecospark ${ }^{\text {® }}$ | MegaBuck ${ }^{\text {TM }}$ | SMART START ${ }^{\text {TM }}$ | TranSiC ${ }^{\text {m }}$ |
| EfficientMax ${ }^{\text {TM }}$ | MICROCOUPLER ${ }^{\text {™ }}$ | Solutions for Your Success ${ }^{\text {SM }}$ SPM | TriFault Detect ${ }^{\text {TM }}$ * |
| ESBC' ${ }^{\text {™ }}$ | MicroFET ${ }^{\text {M }}$ | STEALTH ${ }^{\text {TM }}$ | TRUECURRENT** <br> $\mu$ SerDes ${ }^{T M}$ |
|  | MicroPak ${ }^{\text {™ }}$ | $\text { SuperFET }{ }^{\circledR}$ | ${ }^{\mu}$ |
| Fairchild ${ }^{\text {® }}$ | MicroPak2 ${ }^{\text {TM }}$ | SuperSOT ${ }^{\text {m/ }} 3$ | SerDes |
| Fairchild Semiconductor ${ }^{\text {® }}$ | MillerDrive ${ }^{\text {min }}$ | SuperSOT ${ }^{\text {TM-6 }} 6$ | UHC ${ }^{\text {(1) }}$ |
| FACT Quiet Series ${ }^{\text {™ }}$ | $\begin{aligned} & \text { MotionMax }{ }^{\text {TM }} \\ & \text { mWSaver } \end{aligned}$ | SuperSOT ${ }^{\text {TM }}$ - 8 | Ultra FRFET ${ }^{\text {m }}$ |
| FACT ${ }^{\text {® }}$ |  | SupreMOS ${ }^{\text {® }}$ | UniFET ${ }^{\text {m }}$ |
| FAST ${ }^{\text {® }}$ | OPTOLOGIC ${ }^{\text {® }}$ | SyncFET ${ }^{\text {m }}$ | VCX ${ }^{\text {TM }}$ |
| FastvCore ${ }^{\text {TM }}$ | OPTOPLANAR ${ }^{\circledR}$ | Sync-Lock ${ }^{\text {TM }}$ | Visual Max ${ }^{\text {TM }}$ |
| FETBench ${ }^{\text {™ }}$ |  | 5GENERAL ${ }_{\text {® }}$ | VoltagePlus ${ }^{\text {TM }}$ |
| FlashWriter ${ }^{\text {® }}$ FPS ${ }^{\text {тM }}$ |  |  | XS ${ }^{\text {™ }}$ |

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Definition of Terms

| Datasheet Identification | Product Status | Definition |
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